



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



- Status Indicating LED on X4 Series and 4A Fuse
- UL, CSA, and CE
- Zero Cross Switching

Solid state I/O switching modules deliver an electrically clean, photo-isolated, noise-free "output" interface from logic level control systems to external loads such as motors, valves, solenoids, etc. -- or an "input" interface from the load or sensors to microprocessor or computer-based logic level systems. Designed for long, reliable service in demanding industrial environments.

## INPUT SPECIFICATIONS

|  | OAC5<br>(S)MOAC5<br>X4OAC5 | OAC15<br>(S)MOAC15<br>X4OAC15 | OAC24<br>(S)MOAC24<br>X4OAC24 | OAC5A<br>(S)MOAC5A<br>X4OAC5A | OAC15A<br>(S)MOAC15A<br>X4OAC15A | OAC24A<br>(S)MOAC24A<br>X4OAC24A |
|--|----------------------------|-------------------------------|-------------------------------|-------------------------------|----------------------------------|----------------------------------|
| Nominal Input Voltage [Vdc]                  | 5                          | 15                            | 24                            | 5                             | 15                               | 24                               |
| Min. Input Voltage @ pin 3 [Vdc] (X4 Series) | 3.0 (4)                    | 8.5 (10)                      | 16.5 (18)                     | 3.0 (4)                       | 8.5 (10)                         | 16.5 (18)                        |
| Max. Input Voltage @ pin 3 [Vdc] (X4 Series) | 8.0 (7.5)                  | 18.5 (20)                     | 29.0 (30.5)                   | 8.0 (7.5)                     | 18.5 (20)                        | 29.0 (30.5)                      |
| Must Turn Off Voltage [Vdc]                  | 1.0                        | 1.0                           | 1.0                           | 1.0                           | 1.0                              | 1.0                              |
| Typical Input Current [mA <sub>dc</sub> ]    | 10                         | 10                            | 10                            | 10                            | 10                               | 10                               |
| Max. Input Current [mA <sub>dc</sub> ]       | 27                         | 20                            | 13.5                          | 27                            | 20                               |                                  |
| Nominal Input Resistance [ohm]               | 240                        | 900                           | 2.2K                          | 240                           | 900                              | 2.2K                             |

## OUTPUT SPECIFICATIONS

|   |     |     |     |     |     |     |
|---|-----|-----|-----|-----|-----|-----|
| Nominal Line Voltage [V <sub>rms</sub> ]            | 120 | 120 | 120 | 240 | 240 | 240 |
| Max. Line Voltage [V <sub>rms</sub> ]               | 140 | 140 | 140 | 280 | 280 | 280 |
| Min. Line Voltage [V <sub>rms</sub> ]               | 12  | 12  | 12  | 24  | 24  | 24  |
| Max. Peak Off-State Voltage [V <sub>peak</sub> ]    | 400 | 400 | 400 | 600 | 600 | 600 |
| Max. Off-State Leakage Current [mA <sub>rms</sub> ] | 2.5 | 2.5 | 2.5 | 4.5 | 4.5 | 4.5 |
| Static Off-State (dv/dt)[V/μs]                      | 200 | 200 | 200 | 200 | 200 | 200 |
| Max. On-State Current [A <sub>rms</sub> ]           | 3   | 3   | 3   | 3   | 3   | 3   |
| Min. On-State Current [mA <sub>rms</sub> ]          | 50  | 50  | 50  | 50  | 50  | 50  |
| Max. One Cycle Surge [A <sub>peak</sub> ]           | 100 | 100 | 100 | 100 | 100 | 100 |
| Peak On-State Voltage [V <sub>peak</sub> ]          | 1.6 | 1.6 | 1.6 | 1.6 | 1.6 | 1.6 |
| Max. Turn-On Time [cycles]                          | 1/2 | 1/2 | 1/2 | 1/2 | 1/2 | 1/2 |
| Max Turn-Off Time [cycles]                          | 1/2 | 1/2 | 1/2 | 1/2 | 1/2 | 1/2 |
| Derating [mA per ° above 25° C]                     | 33  | 33  | 33  | 33  | 33  | 33  |
| Fuse Rating [fast-acting] (X4 Series Only)          | 4A  | 4A  | 4A  | 4A  | 4A  | 4A  |

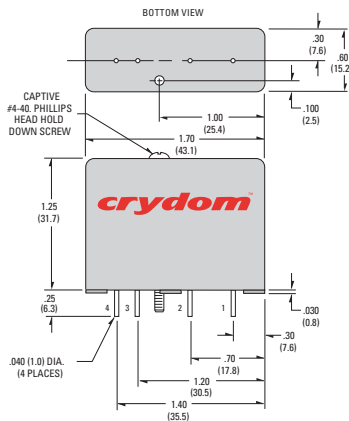
© 2007 CRYDOM Inc., Specifications subject to change without notice.

## GENERAL SPECIFICATIONS

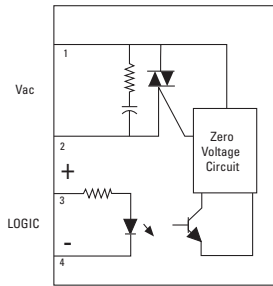
|                             |               |
|-----------------------------|---------------|
| Operating temperature range | -30 to +80°C  |
| Storage temperature range   | -40 to +100°C |
| Isolation                   | 4,000 Vrms    |
| Capacitance input to output | 8 pF          |
| Line frequency range        | 47 to 63 Hz   |
| Package Color               | Black         |

## WIRING & MECHANICAL DIAGRAMS

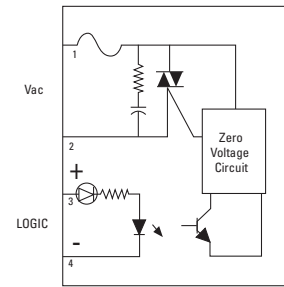
### Standard Series, OAC



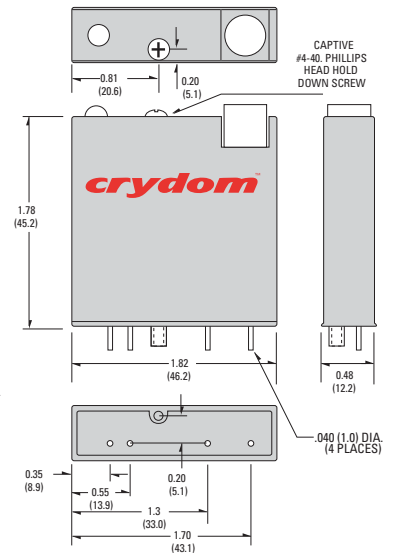
### Standard and Mini Pack



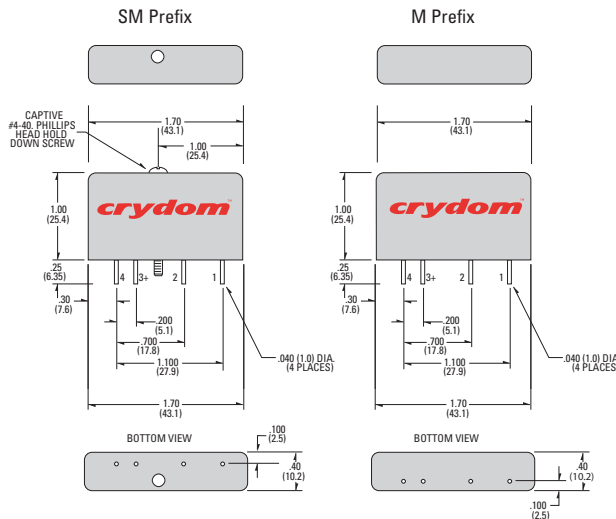
### X4 Series



### X4 Series, X40AC



### MINI-PACK Series, (S)MOAC



## APPLICATION NOTES

- Do not install or remove modules in live (electrically hot) circuits. High voltage may be present.
- An externally located commutating diode must be installed across inductive loads
- I/O module boards also available

All dimensions are in inches (millimeters)

© 2007 CRYDOM Inc., Specifications subject to change without notice.

For recommended applications and more information contact:  
**USA:** Sales Support (877) 502-5500 Tech Support (877) 702-7700 FAX (619) 710-8540  
 Crydom Inc., 2320 Paseo de las Americas, Ste. 201, San Diego, CA 92154  
**Email:** sales@crydom.com **WEB SITE:** http://www.crydom.com  
**UK:** +44 (0)1202 606030 • **FAX** +44 (0)1202 606035 Crydom SSR Ltd., Arena Business Centre,  
 Holyrood Close, Poole, Dorset BH17 7FJ, Email: intsales@crydom.com.  
**GERMANY:** +49 (0)180 3000 506



## ANNEX – ENVIRONMENTAL INFORMATION:

The environmental information disclosed in this annex including the EIP Pollution logo are in compliance with People's Republic of China Electronic Industry Standard SJ/T11364 – 2006, Marking for Control of Pollution Caused by Electronic Information Products.

| Part Name         | Toxic or hazardous Substance and Elements |              |              |                               |                                |                                       |
|-------------------|---|--------------|--------------|-------------------------------|--------------------------------|---------------------------------------|
|                   | Lead (Pb)                                 | Mercury (Hg) | Cadmium (Cd) | Hexavalent Chromium (Cr (VI)) | Polybrominated biphenyls (PBB) | Polybrominated diphenyl ethers (PBDE) |
| Semiconductor die | X   | O            | O            | O                             | O                              | O                                     |
| Solder            | X   | O            | O            | O                             | O                              | O                                     |

### 附件 - 环保信息:

此附件所标示的包括电子信息产品污染图标的环保信息符合中华人民共和国电子行业标准 **SJ/T11364 - 2006**, 电子信息产品污染控制标识要求

| 部件名称  | 有毒有害物质或元素 |        |        |               |            |              |
|-------|-----------|--------|--------|---------------|------------|--------------|
|       | 铅 (Pb)    | 汞 (Hg) | 镉 (Cd) | 六价铬 (Cr (VI)) | 多溴联苯 (PBB) | 多溴二苯醚 (PBDE) |
| 半导体芯片 | X         | O      | O      | O             | O          | O            |
| 焊接点   | X         | O      | O      | O             | O          | O            |

